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<http://www.smics.com>

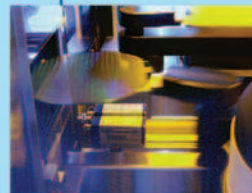


Design Service Support

Mask Making



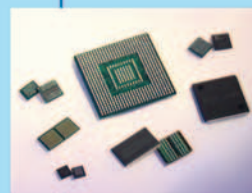
Wafer Manufacturing



Wafer Bumping



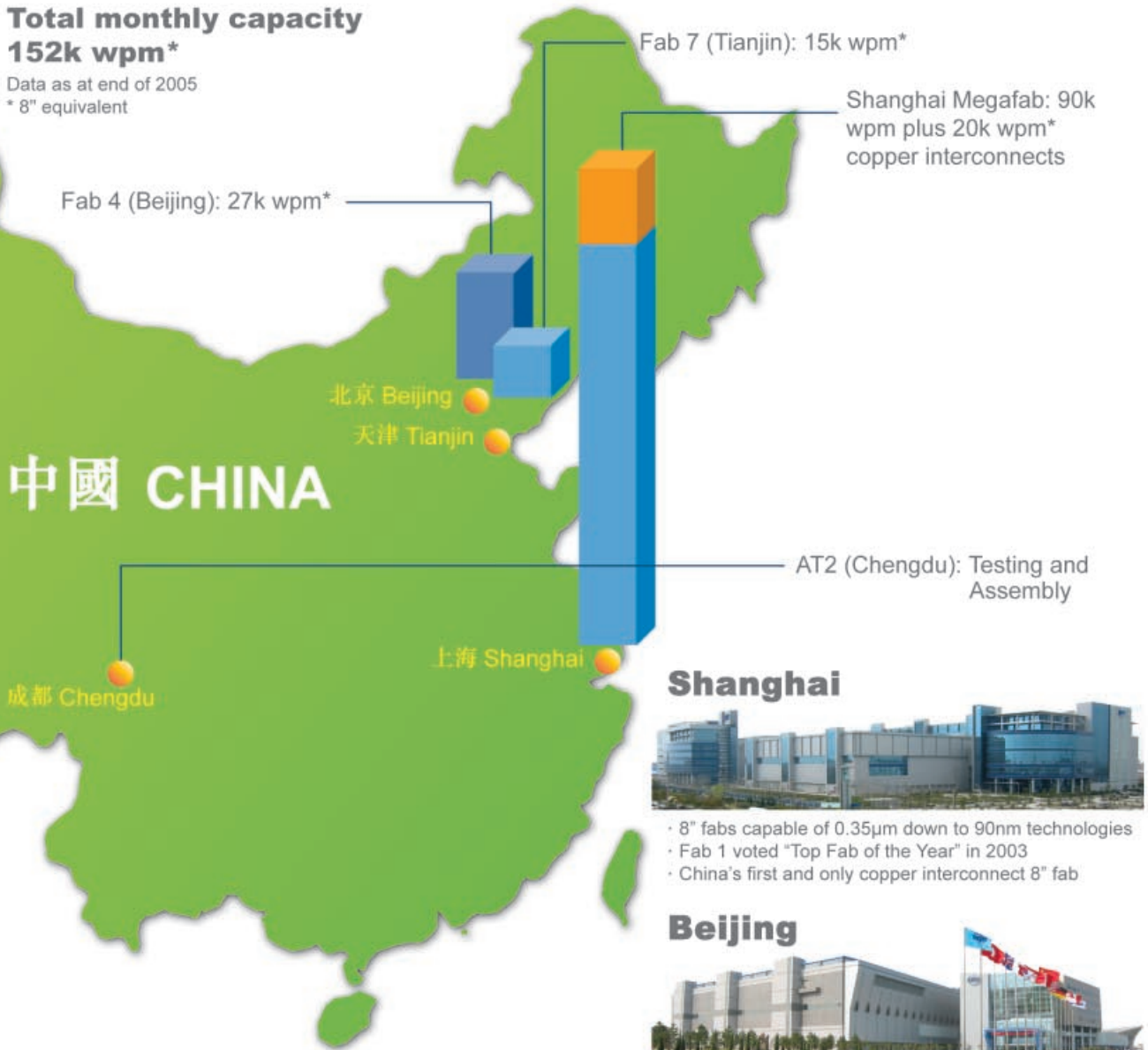
Assembly & Testing



SMIC - The largest and most advanced foundry in China

Total monthly capacity
152k wpm*

Data as at end of 2005
 * 8" equivalent



中國 CHINA

成都 Chengdu

北京 Beijing

天津 Tianjin

上海 Shanghai

Fab 7 (Tianjin): 15k wpm*

Shanghai Megafab: 90k wpm plus 20k wpm* copper interconnects

AT2 (Chengdu): Testing and Assembly

Shanghai



- 8" fabs capable of 0.35 μ m down to 90nm technologies
- Fab 1 voted "Top Fab of the Year" in 2003
- China's first and only copper interconnect 8" fab

Beijing



- The first 12" fab in China
- 0.15 μ m to 90nm technologies
- China's first and only copper interconnect 12" fab

Tianjin



- 8" fab offering 0.35 μ m to 0.15 μ m technologies

Chengdu

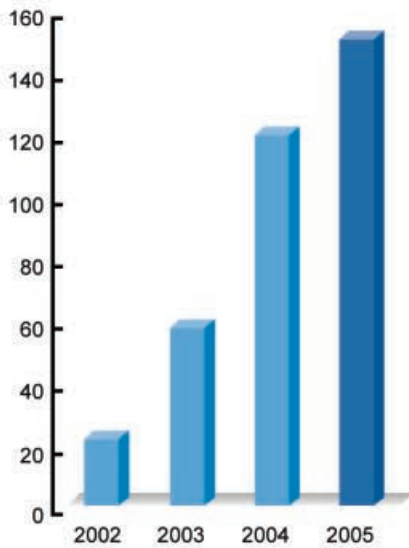


- In-house testing & assembly for a "turn-key" solution in China
- Now entered production

"SMIC became the third largest dedicated foundry in the world in 2005. It occupied over 50% of China's foundry market."

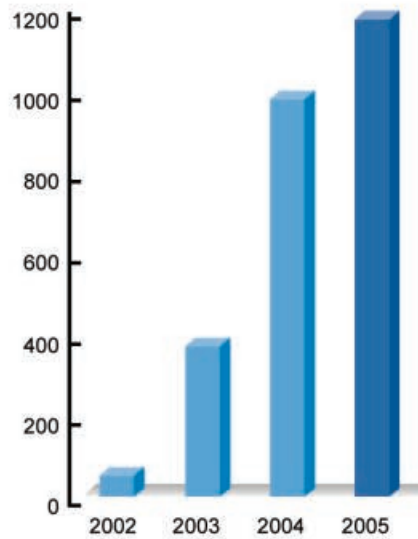
source: leading technology market research

Monthly Capacity
(thousands) *



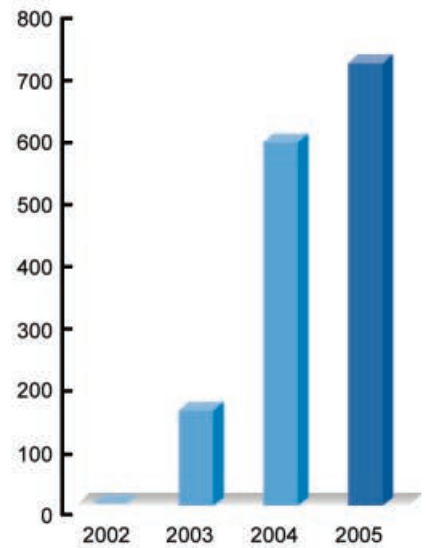
* 8" equivalent

Sales
(US\$m) **



** Audited

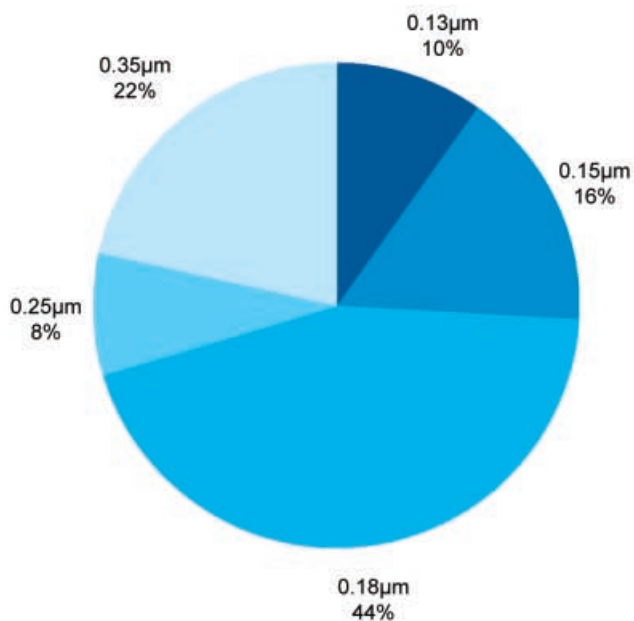
EBITDA
(US\$m) ***



*** EBITDA (Earnings Before Interests, Taxes, Depreciation and Amortization)

“ We have upgraded our wafer capacity to generate more revenue from advanced technology nodes. ”

Beginning of 2004 (1Q04)



End of 2005 (4Q05)

